



Parameter	Rating	Units
Blocking Voltage	70	V _P
Load Current	150	mA _{rms} / mA _{DC}
On-Resistance (max)	16	Ω
LED Current to Operate	1	mA

Transient Protection Characteristics

Peak Pulse Power	V _{WM}
600W	40.2V

Features

- Meets Requirements of EN50130-4 (Installation Class 3)
- 3750V_{rms} Input/Output Isolation
- 100% Solid State
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Security
- Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Aerospace
- Industrial Controls

Description

The CPC1317 is a single-pole, normally open (1-Form-A) solid state relay with bi-directional transient voltage suppressor (TVS) relay protection, which is designed to meet the requirements of EN50130-4 (installation class 3).

The relay output is constructed with efficient MOSFET switches and photovoltaic die that use IXYS Integrated Circuits Division's patented OptoMOS architecture. The input, a highly efficient GaAlAs infrared LED, controls the optically coupled output.

The CPC1317 is available in an 8-pin, space-saving surface-mount package.

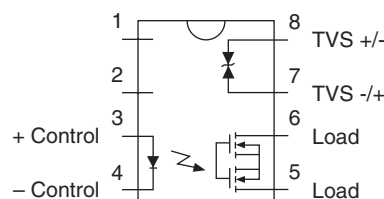
Approvals

- UL Certified Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: TUV Certificate B 10 05 49410 006

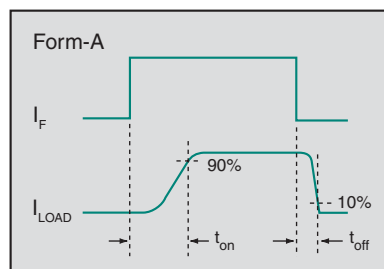
Ordering Information

Part #	Description
CPC1317P	8-Pin Flatpack (50/tube)
CPC1317PTR	8-Pin Flatpack (1000/reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
SSR Output Blocking Voltage	70	V _P
TVS Working Voltage, Maximum	40.2	V
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	150	mW
SSR Output Power Dissipation ²	400	mW
TVS Peak Pulse Power (I _{pp} =9.3A, 10/1000µs pulse)	600	W
Isolation Voltage, Input to Output	3750	V _{rms}
Operating Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

SSR Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous	-	I _L	-	-	150	mA _{rms} / mA _{DC}
Peak	t=10ms	I _{LPK}	-	-	±400	mA _P
On-Resistance ¹	I _L =150mA, I _F =1mA	R _{ON}	-	7	16	Ω
Off-State Leakage Current	V _L =70V _P	I _{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	2.5	ms
Turn-Off		t _{off}	-	-	2.5	
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current to Activate ²	I _L =150mA	I _F	-	-	1	mA
Input Dropout Current to Deactivate	-	I _F	0.1	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Common Characteristics						
Capacitance, Input to Output	-	C _{I/O}	-	3	-	pF

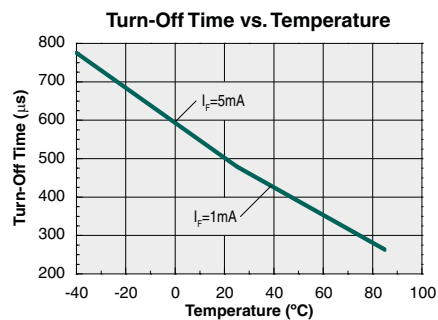
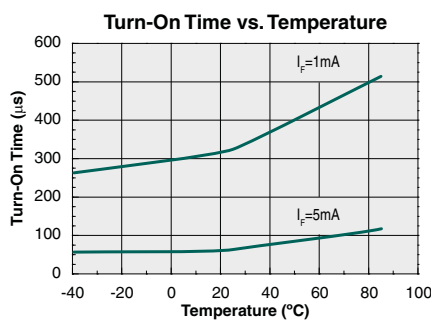
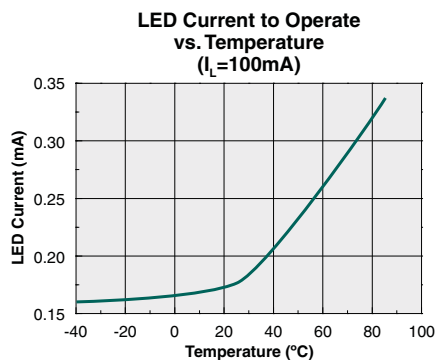
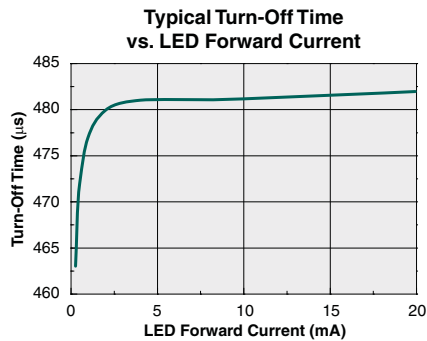
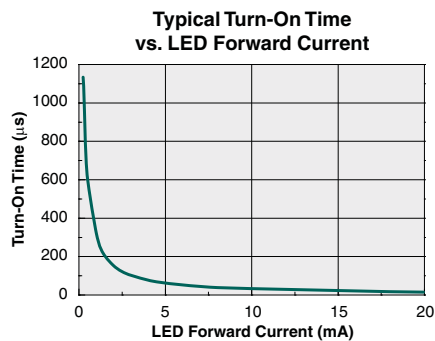
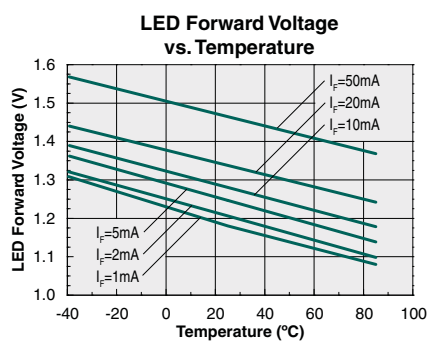
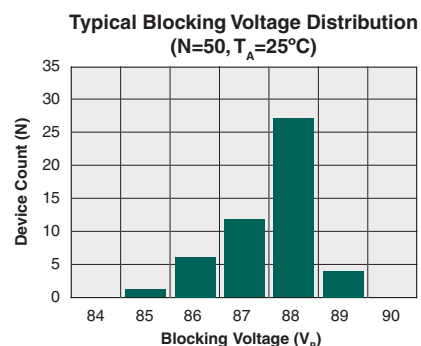
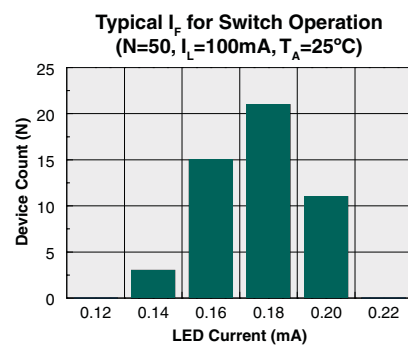
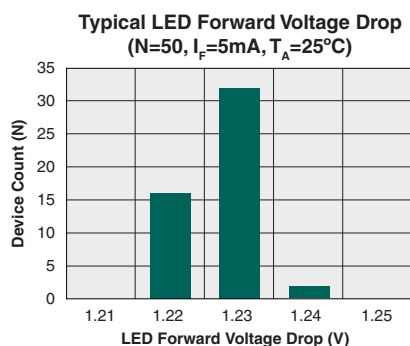
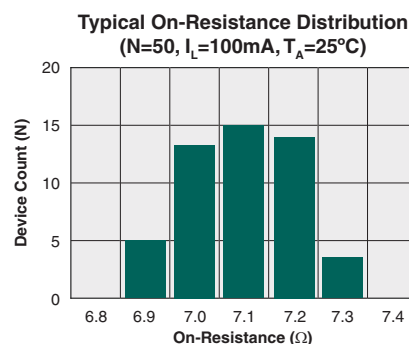
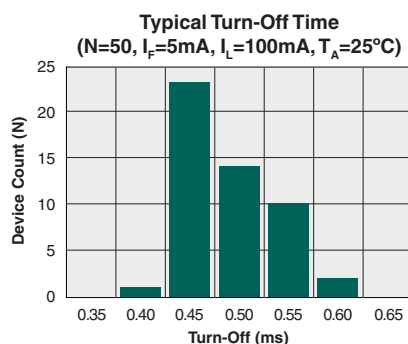
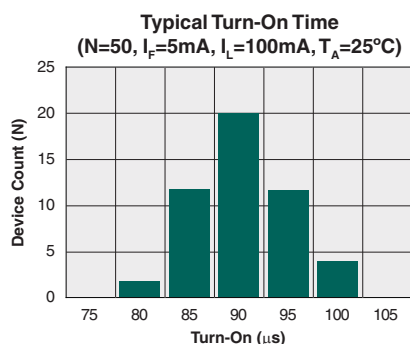
¹ Measurement taken within 1 second of turn-on time.

² For applications requiring high temperature operation (> 60°C) a minimum LED drive current of 3mA is required.

TVS Electrical Characteristics

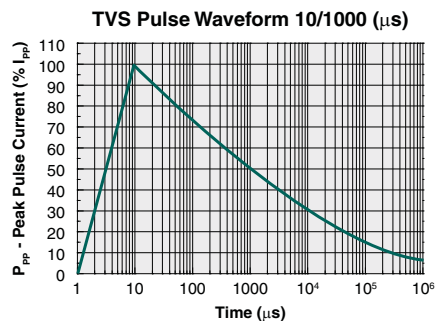
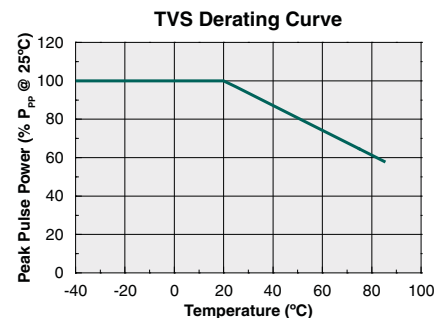
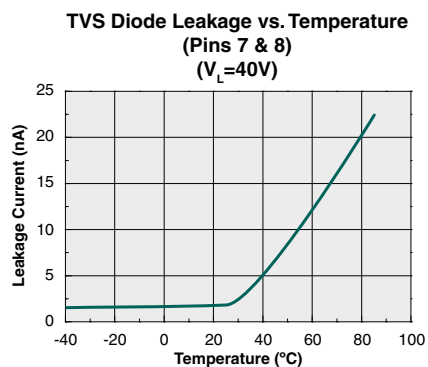
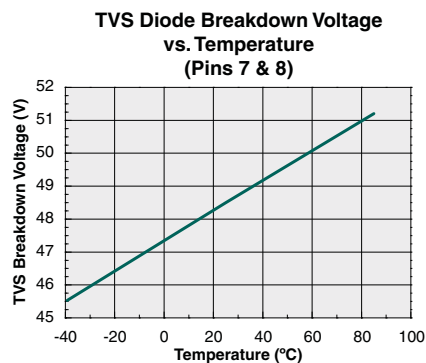
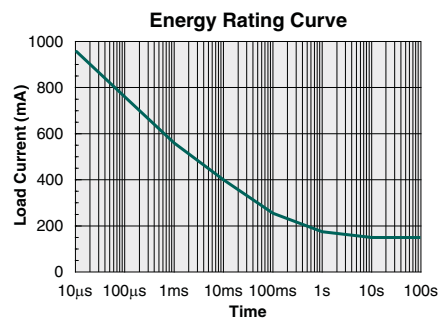
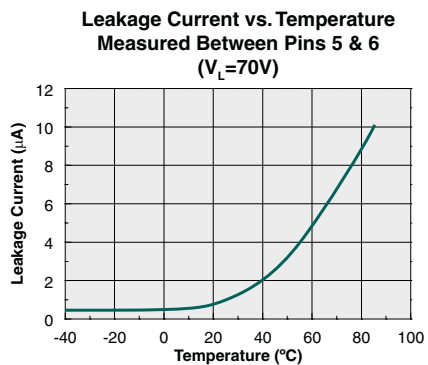
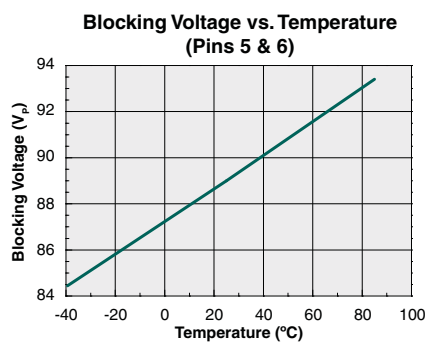
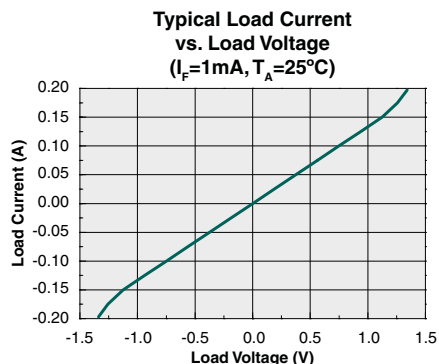
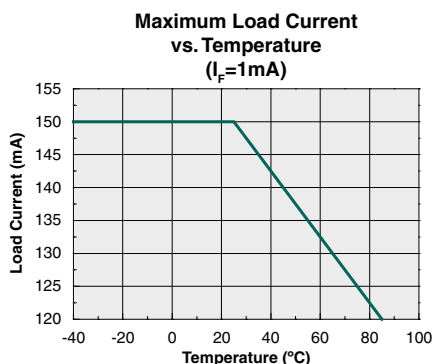
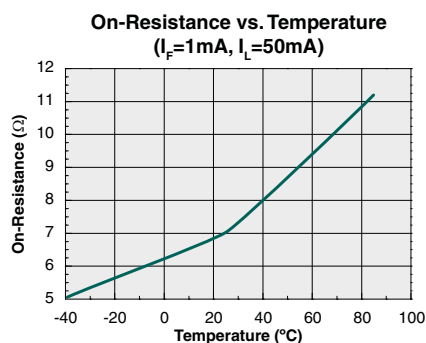
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Clamping Voltage	I _{pp} =9.3A	V _C	-	-	66.5	V
Reverse Breakdown Voltage	I=1mA	V _{BR}	44.4	-	-	V
Reverse Leakage Current	V _{WM} =40.2V	I _L	-	-	5	µA

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1317P	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1317P	260°C for 30 seconds

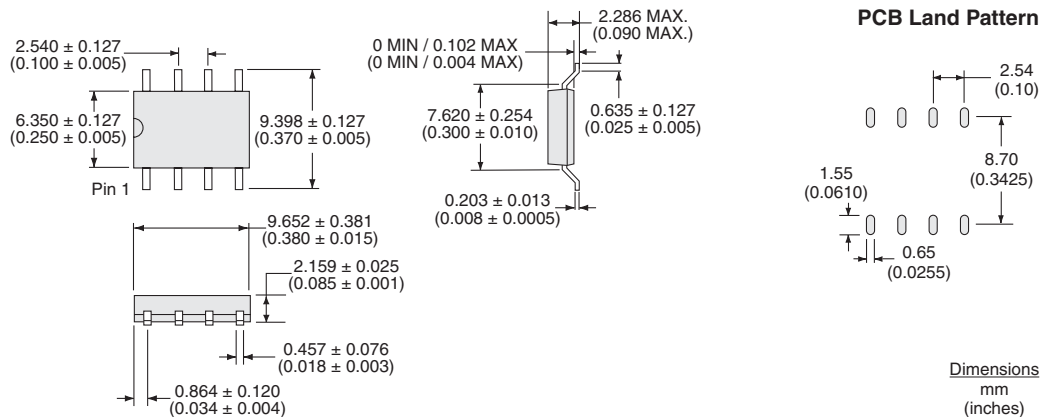
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

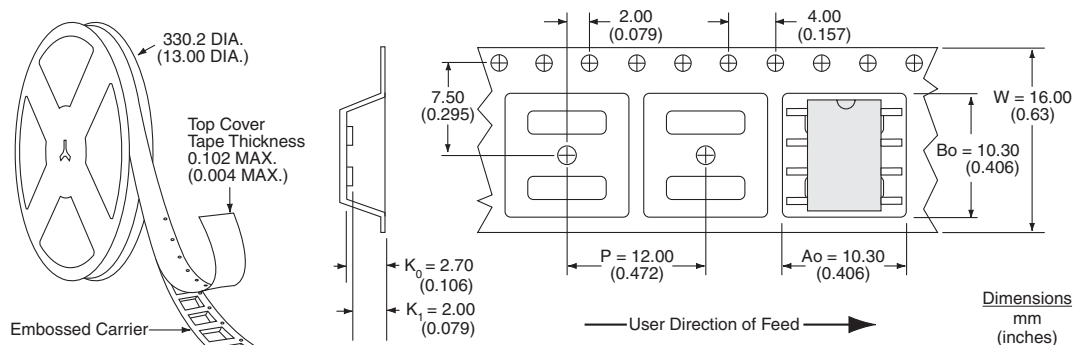


MECHANICAL DIMENSIONS

CPC1317P



CPC1317PTR Tape & Reel



- NOTES:
1. All dimensions carry tolerances of EIA Standard 481-2
 2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com

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